



CTL SH1-40M563

SURFACE MOUNT  
HIGH CURRENT, LOW  $V_F$   
SILICON SCHOTTKY RECTIFIER



LOW  
 $V_F$

Top View Bottom View

TLM563 CASE

**APPLICATIONS:**

- DC/DC Converters
- Reverse Battery Protection
- Battery powered devices including Cell Phones, PDAs, Digital Cameras, MP3 Players, etc.

**MAXIMUM RATINGS:** ( $T_A=25^\circ C$ )

Peak Repetitive Reverse Voltage	$V_{RRM}$	40	V
Continuous Forward Current	$I_F$	1.0	A
Peak Repetitive Forward Current, $t_p \leq 1\text{ms}$	$I_{FRM}$	3.5	A
Forward Surge Current, $t_p = 8.3\text{ms}$	$I_{FSM}$	10	A
Power Dissipation (Note 1)	$P_D$	500	mW
Operating and Storage Junction Temperature	$T_J, T_{stg}$	-65 to +150	$^\circ C$
Thermal Resistance (Note 1)	$\Theta_{JA}$	250	$^\circ C/W$

**central**<sup>TM</sup>  
Semiconductor Corp.

**DESCRIPTION:**

The CENTRAL SEMICONDUCTOR CTL SH1-40M563 is a high quality, low  $V_F$  Schottky Rectifier packaged in a space saving 1.6 x 1.6mm TLM™ surface mount package. This device is a TLM™ equivalent of the popular CML SH1-40, SOT-563 device, featuring enhanced thermal characteristics, a package footprint compatible with standard SOT-563 mounting pad geometries, and a height profile of only 0.4mm.

**MARKING CODE: CJB****FEATURES:**

- Device is **Halogen Free** by design
- High Current ( $I_F=1.0\text{A}$ )
- Low Forward Voltage Drop ( $V_F=0.55\text{V Max @ } 1.0\text{A}$ )
- High Thermal Efficiency
- TLM563 with a package profile of 0.4mm, compatible with SOT-563 mounting geometries

SYMBOL		UNITS
$V_{RRM}$	40	V
$I_F$	1.0	A
$I_{FRM}$	3.5	A
$I_{FSM}$	10	A
$P_D$	500	mW
$T_J, T_{stg}$	-65 to +150	$^\circ C$
$\Theta_{JA}$	250	$^\circ C/W$

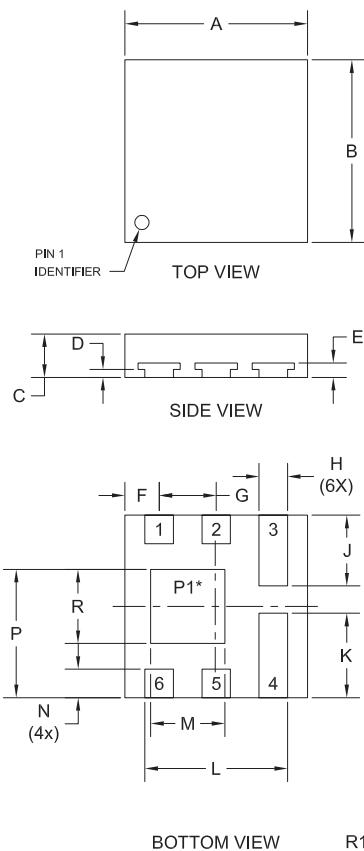
**ELECTRICAL CHARACTERISTICS:** ( $T_A=25^\circ C$  unless otherwise noted)

SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
$I_R$	$V_R=5.0\text{V}$			10	$\mu A$
$I_R$	$V_R=8.0\text{V}$			20	$\mu A$
$I_R$	$V_R=15\text{V}$			50	$\mu A$
$I_R$	$V_R=40\text{V}$			200	$\mu A$
$I_R$	$V_R=40\text{V}, T_A=100^\circ C$			20	mA
$BV_R$	$I_R=100\mu\text{A}$	40			V
$V_F$	$I_F=10\text{mA}$			0.29	V
$V_F$	$I_F=100\text{mA}$			0.36	V
$V_F$	$I_F=500\text{mA}$			0.45	V
$V_F$	$I_F=1.0\text{A}$			0.55	V
$C_J$	$V_R=4.0\text{V}, f= 1.0\text{MHz}$		50		pF
$t_{rr}$	$I_F=I_R=500\text{mA}, I_{rr}=50\text{mA}, R_L=50\Omega$		15		ns

Notes: (1) Mounted on 2 inch square FR4 PCB with copper mounting pad area of 2.4mm<sup>2</sup>.

R0 (27-January 2009)

TLM563 CASE - MECHANICAL OUTLINE

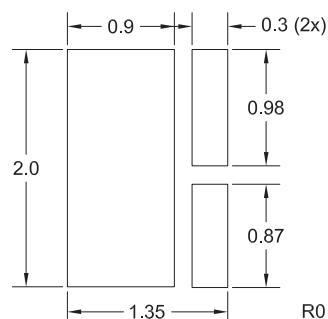


\* Exposed pad P1 common to pins 1, 2, 5, and 6.

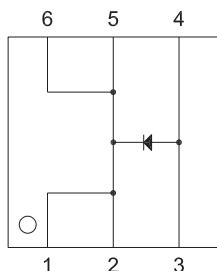
SYMBOL	DIMENSIONS			
	INCHES	MILLIMETERS	MIN	MAX
A	0.062	0.064	1.57	1.63
B	0.062	0.064	1.57	1.63
C	0.014	0.017	0.36	0.43
D	0.002	0.004	0.04	0.10
E	0.004	0.006	0.10	0.16
F	0.011	0.013	0.27	0.33
G	0.019	0.021	0.47	0.53
H	0.009	0.011	0.22	0.28
J	0.023	0.026	0.59	0.65
K	0.028	0.030	0.71	0.77
L	0.048	0.050	1.22	1.28
M	0.024	0.027	0.62	0.68
N	0.009	0.011	0.22	0.28
P	0.043	0.045	1.09	1.16
R	0.024	0.027	0.62	0.68

TLM563 (REV:R1)

SUGGESTED MOUNTING PADS  
(Dimensions in mm)



PIN CONFIGURATION



LEAD CODE:

- 1) CATHODE
- 2) CATHODE
- 3) ANODE
- 4) ANODE
- 5) CATHODE
- 6) CATHODE

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